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Publication Details

Fu, H., You, C., Ma, L., Tian, N., Xin, F., Cheng, Z., Basha, A. & Kohn, A. (2018). Interfacial contributions to anomalous Hall effect in perpendicular magnetic anisotropic [Co2MnSi/Pd]3 multilayer. Physical Review Materials, 2 (12), 124404-1-124404-8.

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Abstract

Through engineering the interface between Co2MnSi and Pd, we realize a high perpendicular magnetic anisotropy (PMA) and controllable anomalous Hall effect (AHE) in [Co2MnSi(tCMS)/Pd]3multilayers. The multilayers are characterized by a particulatelike layer morphology following annealing at 573 K with weak B2 crystallographic ordering of the Co2MnSi layer. The largest PMA (Keff) of 1.2x106erg/cm3 has been obtained in [Co2MnSi(1.2nm)/Pd]3 multilayer annealed at 573 K. The AHE can be tuned, which we attribute to a varying proximity effect at the Co2MnSi/Pd interface, by varying the annealing temperature and Co2MnSi thickness. According to the expanded AHE scaling relation, we calculate the different contributions to the origin of AHE. Both skew scattering and side jump decrease monotonically with increasing Co2MnSi thickness, but show maximum values for the multilayer annealed around 573 K with increasing annealing temperature. It is found that skew scattering ρ ss is larger than the value of side jump 11\rhosj11, giving a ρ ss value of approximately 1.34 μ \Omega cm and the absolute 11\rhosj11 value of 1.1 μ Ω cm at 5 K in [Co2MnSi(1.2nm)/Pd]3 multilayer, indicating that the overall AHE originates mostly from the skew scattering.

Keywords

hall, [co2mnsi/pd]3, anomalous, multilayer, interfacial, effect, contributions, perpendicular, magnetic, anisotropic

Disciplines

Engineering | Physical Sciences and Mathematics

Publication Details

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Interfacial contributions to anomalous Hall effect in perpendicular magnetic anisotropic [Co₂MnSi/Pd]₃ multilayer

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(Received 4 July 2018; published 28 December 2018)

Through engineering the interface between Co₂MnSi and Pd, we realize a high perpendicular magnetic anisotropy (PMA) and controllable anomalous Hall effect (AHE) in $[Co_2MnSi (t_{CMS})/Pd]_3$ multilayers. The multilayers are characterized by a particulatelike layer morphology following annealing at 573 K with weak B2 crystallographic ordering of the Co₂MnSi layer. The largest PMA (K_{eff}) of 1.2×10^6 erg/cm³ has been obtained in $[Co_2MnSi (1.2 \text{ nm})/Pd]_3$ multilayer annealed at 573 K. The AHE can be tuned, which we attribute to a varying proximity effect at the Co₂MnSi/Pd interface, by varying the annealing temperature and Co₂MnSi thickness. According to the expanded AHE scaling relation, we calculate the different contributions to the origin of AHE. Both skew scattering and side jump decrease monotonically with increasing Co₂MnSi thickness, but show maximum values for the multilayer annealed around 573 K with increasing annealing temperature. It is found that skew scattering (ρ_{ss}) and side-jump scattering (ρ_{sj}) exhibit opposite contributions to the AHE; the skew scattering ρ_{ss} is larger than the value of side jump $|\rho_{sj}|$, giving a ρ_{ss} value of approximately 1.34 $\mu\Omega$ cm and the absolute $|\rho_{sj}|$ value of 1.1 $\mu\Omega$ cm at 5 K in $[Co_2MnSi (1.2nm)/Pd]_3$ multilayer, indicating that the overall AHE originates mostly from the skew scattering.

DOI: 10.1103/PhysRevMaterials.2.124404

I. INTRODUCTION

The anomalous Hall effect (AHE) originates from spinorbit interactions, presenting potential applications in magnetic sensors, memories, and logic gates [1-3]. Currently, the AHE of ferromagnetic Heusler alloy films with perpendicular magnetic anisotropy is attracting significant scientific and technological interest due to high spin polarization and reduced Zeeman energy when subjected to a magnetic field [4–6]. The most pressing objectives are to clarify the origin of AHE and therefore to improve the device performance [6,7]. A scaling law between longitudinal resistivity (ρ_{xx}) and anomalous Hall resistivity (ρ_{AH}) has been proposed in order to interpret the physical origin of AHE, which is related to both intrinsic and extrinsic contributions [8-10]. In addition, perpendicular magnetic anisotropy (PMA) is another key factor for improving the performance of magnetic sensors and nonvolatile memory devices, particularly reducing energy consumption and enhancing storage density [7,11]. However, to date, studies relating PMA and AHE of high-spin-polarized Heusler alloy films are very limited, although the PMA-based AHE behavior is of fundamental scientific interest with enormous potential applications.

Regarding the physical origin of AHE, the intrinsic contribution follows a $\rho_{AH} \propto \rho_{xx}^2$ relation, relating to the Berry curvature for Bloch electrons in ferromagnetic materials [8]. Scaling relations of $\rho_{AH} \propto \rho_{xx}$ and $\rho_{AH} \propto \rho_{xx}^2$ are for extrinsic contributions of skew scattering and side jump, respectively, which can be ascribed to the asymmetric scattering of electrons [9,10]. Tian *et al.* proposed the scaling relation for epitaxial thin Fe films deposited on GaAs (001) [12] defined as

$$\rho_{\rm AH} = \rho_{\rm ss} + \rho_{\rm sj} + \rho_{\rm in} = a' \rho_{xx0} + a'' \rho_{xxT} + b \rho_{xx}^2, \qquad (1)$$

where $\rho_{ss} = a' \rho_{xx0} + a'' \rho_{xxT}$ represents a skew scattering contribution. The ρ_{xx0} term is the residual resistivity arising from scattering of impurities and the $\rho_{xxT}(\rho_{xxT} = \rho_{xx} - \rho_{xx0})$ term is the phonon-induced resistivity. The scaling parameters a' and a'' correspond to skew scattering. The ρ_{sj} term is due to the scattering-independent mechanism of side jump and the ρ_{in} term is due to the intrinsic mechanism of bulk relating to Berry curvature, both of which are contributed by $b\rho_{xx}^2$. The scaling parameter *b* corresponds to both intrinsic mechanism and side jump. The scaling relation in Eq. (1) allows one to quantify the contribution of skew scattering. The contribution of the side-jump mechanism can be quantified by excluding the contribution from the intrinsic mechanism or directly evaluated in ultrathin films where the bulk intrinsic contribution is negligible [13].

The interface between ferromagnetic (FM) and nonferromagnetic (NM) layers results in various phenomena, such as the magnetic proximity effect, interfacial Rashba effect, and controllable spin-orbit coupling, all of which are critical to electrical transport properties including AHE, spin Hall effect, and other spin-related effects [14–16]. Studies reported that the magnitude of AHE can be strengthened by the addition of nonferromagnetic impurities into bulk ferromagnets [17], enhancing surface/interface scattering through

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granular films [18], multilayer films [19], incorporating the semiconducting layer into magnetic films [20], and achieving PMA [7,11]. Studies of AHE related to PMA have focused on FM/NM bilayer, trilayer, or multilayer with transition-metal FM layers such as Co, Fe, or CoFeB, and NM layers such as Pd, Pt, HfO₂, or MgO [21-26]. Recently, Co-based Heusler alloys have attracted intense attention as potential candidates for spintronic devices due to their high Curie temperature and half-metallic electronic structure [5,27]. Reported AHE studies on Co-based Heusler alloys include bulk, granular film, bilayer, or trilayer systems, such as bulk $Co_2MnSi_{1-x}Al_x$ [28], $Co_2FeSi-Al_2O_3$ granular films, Co₂MnAl, Co₂FeSi, Co₂FeAl, Co₂MnGe, and Co₂MnSi monolayers [6,29–31], Pt/Co₂FeAl bilayer [32], or MgO/Co₂MnGa/Pd trilayer [33]. In our previous report, a large PMA was realized in Pd/Co₂MnSi/MgO trilayer, which was attributed to the interfacial orbital hybridization adjacent to the Heusler alloy Co₂MnSi layer, namely, Pd/Co₂MnSi and Co₂MnSi/MgO interfaces [34]. In addition, the enhanced AHE was observed in Pd/Co₂MnSi/MgO multilayer with PMA behavior [35].

Therefore, it can be concluded that the AHE and PMA can be controlled through interfacial engineering, and improved AHE is expected from a perpendicularly magnetized FM layer in Heusler alloy/NM multilayer films [35]. Understanding these interfacial phenomena is a key objective to clarify the source of AHE in Co-based Heusler alloys and consequently its utilization in devices. In this work, we incorporated and examined interfacial contributions into the design of $[Co_2MnSi (t_{CMS})/Pd]_3$ multilayer films to show that PMA and AHE can be tuned by annealing temperature and thickness of the FM Co₂MnSi layer. The role of interface is examined by relating the structure of the multilayers to their transport properties. We applied the expanded scaling relation [12] to elucidate that both skew scattering ρ_{ss} and side jump $|\rho_{\rm si}|$ contribute to AHE origin in $[{\rm Co}_2{\rm MnSi}(t_{\rm CMS})/{\rm Pd}]_3$ multilayers, with the dominant mechanism being skew scattering compared to the side-jump mechanism.

II. EXPERIMENT

Multilayer stacks of Pd $(8 \text{ nm})/[\text{Co}_2\text{MnSi}(t_{\text{CMS}})/\text{Pd}(1.6 \text{ nm})]_3/\text{Pd}(4 \text{ nm})(t_{\text{CMS}} = 0.7-2.1 \text{ nm})$ (referred to as $[\text{Co}_2\text{MnSi}(t_{\text{CMS}})/\text{Pd}]_3$) were deposited on Si/SiO₂ (500 nm) substrates by magnetron sputtering (MSP3220, Beijing Jinshengweina Technology Co., Ltd.) under a base pressure of below 3×10^{-5} Pa at room temperature. The Pd layer was deposited under Ar pressure of 0.3 Pa with dc power of 10 W. The Co₂MnSi layer was deposited under Ar pressure of 0.3 Pa with dc power of 20 W using a Co₂MnSi target (99.5% purity, Heifei Kejing Materials Technology Co., Ltd.). The thickness of each layer was calibrated by comparison to cross-sectional micrographs obtained by transmission electron microscopy.

The multilayers were then annealed in a vacuum chamber of better than 10^{-5} Pa for 30 min, at temperatures between 523 and 623 K. The thicknesses and roughness of multilayer films were characterized with x-ray reflectivity (XRR, XRD-7000, Shimadzu Limit, Cu K α radiation). The crystallographic structure of the ultrathin layers was characterized by Cs-corrected high-resolution (phase contrast) transmission electron microscopy (TEM) (FEI Titan, 300 kV) in order to reduce delocalization of information [36]. Further qualitative compositional characterizations of the multilayers were achieved by Z-contrast (high-angle annular dark-field) scanning TEM (JEOL JEM 2100F, 200 kV). Selected samples were prepared for cross-sectional observation, aligning the multilayers edge-on along the Si [110] zone axis. The TEM samples were prepared by mechanical polishing and lowenergy Ar ion milling. The magnetic properties of multilayers were measured by VSM integrated into a physical property measurement system (PPMS, Quantum Design PPMS-9). Electrical transport measurements (Hall effect, electrical resistance, and magnetoresistance) were performed on the multilayers with $10 \times 10 \text{ mm}^2$ Hall bar profile by PPMS at temperatures between 5 and 300 K.

III. RESULTS AND DISCUSSION

A. Structural characterization

Figure 1(a) shows the x-ray reflectivity (XRR) pattern of [Co₂MnSi (1.2 nm)/Pd]₃ multilayers following different annealing temperatures. The numbers of Kiessig fringes are approximately constant with the increase of annealing temperature, indicating similar roughness in the multilayer. Figures 1(b) and 1(c) show typical cross-sectional Cs-corrected high-resolution (HR)TEM micrographs, here of the [Co₂MnSi (1.2 nm)/Pd]₃ multilayer, annealed at 573 K, which exhibits both high PMA and AHE (shown later). The contrast variations are attributed predominately to Co₂MnSi and Pd regions. The power spectra of the Fourier transform from the region denoted schematically by the red rectangle [inset of Fig. 1(b)] shows peaks attributed mostly to crystal periodicities with cubic symmetry of {220} and {400} planes, and minor peaks attributed to periodicities of {200} and {420} planes, indicating a B2 ordered structure of Co₂MnSi. This observation is in agreement with our previous work on the B2 ordered structure of Co₂MnSi film annealed at 573 K [34]. Other periodicities in the power spectrum, marked schematically by blue circles, denote Pd {111} and {311} planes. The Z-contrast high-angle annular dark-field (HAADF) scanning transmission electron microscopy (STEM) micrograph [Fig. 1(d)] highlights a compositional particulate-layer morphology [36]. The top and bottom Co₂MnSi layers (relatively dark contrast) are observed to be partially continuous, while the second, intermediate Co₂MnSi layer cannot be differentiated from the Pd layer.

B. Perpendicular magnetic anisotropy (PMA)

Figures 2(a)-2(c) show magnetic hysteresis (*M-H*) loops measured along in-plane and out-of-plane directions at room temperature for $[Co_2MnSi(t_{CMS})/Pd]_3$ multilayers following different annealing temperatures and Co_2MnSi thicknesses. As seen from Fig. 2(a), the as-deposited $[Co_2MnSi(1.2 \text{ nm})/Pd]_3$ multilayer presents an in-plane magnetic anisotropy (IMA). After annealing at 573 K, the easy axis of magnetization was shifted from the in-plane direction to out-of-plane direction, exhibiting a strong PMA behavior, as shown in Fig. 2(b). For the $[Co_2MnSi(2.1 \text{ nm})/Pd]_3$ multilayer annealed at 573 K, a



FIG. 1. (a) XRR spectra of [Co₂MnSi (1.2 nm)/Pd]₃ multilayers after several annealing temperatures. (b) Cross-sectional Cs-corrected HRTEM micrograph of [Co₂MnSi (1.2 nm)/Pd]₃ multilayer after annealing at 573 K. Inset: Power spectrum of area marked schematically by red square. (c), (d) Cross-sectional Cs-corrected HRTEM and Z-contrast HAADF STEM micrographs, respectively.

relatively weak PMA behavior was observed, as seen in Fig. 2(c), implying that increasing Co_2MnSi thickness tends to weaken the PMA.

In order to quantify the PMA, the effective anisotropy energy (K_{eff}) is plotted with respect to total Co₂MnSi thickness (t'_{CMS}) and annealing temperature (T_{ann}) in Fig. 2(d). K_{eff} is calculated using the empirical relationship $K_{\text{eff}} = H_k M_s/2$, in which H_k , the anisotropy field, and M_s , the saturation magnetic moment, are extracted from the *M*-*H* loops, as

shown in Table I. Positive K_{eff} values indicate the PMA behavior of the film. As shown in Fig. 2(d), regarding the as-deposited films, the positive K_{eff} value for PMA can only be obtained at $t_{\text{CMS}} = 0.7 \text{ nm}$ ($t'_{\text{CMS}} = 2.1 \text{ nm}$), and the IMA becomes strong with increasing t_{CMS} , showing large negative K_{eff} values.

Through fitting the phenomenological relation [37],

$$K_{\rm eff} \times t'_{\rm CMS} = \left(K_{\rm V} - 2\pi M_s^2\right) \times t'_{\rm CMS} + K_s, \qquad (2)$$



FIG. 2. *M-H* loops measured along in-plane and out-of-plane directions for (a) as-deposited $[Co_2MnSi(1.2 \text{ nm})/Pd]_3$, (b) annealed $[Co_2MnSi(1.2 \text{ nm})/Pd]_3$, and (c) $[Co_2MnSi(2.1 \text{ nm})/Pd]_3$ multilayers annealed at 573 K. (d) Dependence of K_{eff} on t'_{CMS} for $[Co_2MnSi(t_{CMS})/Pd]_3$ multilayers following different annealing temperatures.

	<u> </u>				
t _{CMS}	Parameters	300 K	523 K	573 K	623 K
0.7 nm	$M_{\rm s}({\rm emu/cm^3})$	508.4	470.9	450.2	400.4
	$H_{\rm k}({\rm Oe})$	2277	849	1185	0
1.2 nm	$M_{\rm s}({\rm emu/cm^3})$	668.3	723.5	833.9	789.6
	$H_{\rm k}({\rm Oe})$	-1456	2142	2974	946
1.6 nm	$M_{\rm s}({\rm emu/cm^3})$	670.1	697.8	742.3	770.0
	$H_{\rm k}({\rm Oe})$	-2332	1682	2508	2007
2.1 nm	$M_{\rm s}({\rm emu/cm^3})$	670.2	680.3	686.3	723.2
	$H_{\rm k}({\rm Oe})$	-3062	882	2201	2249

for the as-deposited $[Co_2MnSi (1.2 nm)/Pd]_3$ multilayer, the interfacial anisotropy (K_s) value of 0.18 erg/cm^2 and the bulk anisotropy (K_V) value of $\sim 10^5 \text{ erg/cm}^3$ are evaluated, respectively. As for all annealed films, PMA can be observed for t_{CMS} in the range of 0.7 to 2.1 nm for all annealing temperatures. The maximum measured K_{eff} value is around $1.2 \times 10^6 \text{ erg/cm}^3$ for $[Co_2MnSi (1.2 nm)/Pd]_3$ multilayer annealed at 573 K. In addition, we note that for the thicker Co_2MnSi layer, a higher annealing temperature is required to achieve PMA in $[Co_2MnSi (t_{CMS})/Pd]_3$ multilayers.

Since the PMA originates from the orbital hybridization 3d of ferromagnetic metallic atoms and 5d of noble metallic atoms at the FM/noble metal interface in its bilayer or multilayer systems, the interfacial quality plays a significant role in developing PMA [38]. For $[Co_2MnSi(t_{CMS})/Pd]_3$ multilayers with t_{CMS} of 1.2 nm, as seen in Fig. 2(d), PMA was measured following annealing due to improved crystallinity of the Co₂MnSi layer and an increased Co₂MnSi/Pd interfacial proximity effect. However, for annealing temperatures above 573 K, this interfacial effect may be deteriorated due to intermixing or diffusion at the Co₂MnSi/Pd

interface, which suppresses orbital hybridization, thus weakening the PMA [13,34]. We conclude that achieving PMA in $[Co_2MnSi (t_{CMS})/Pd]_3$ multilayers depends on the combination of annealing temperature and Co_2MnSi thickness [13,39,40].

Figures 3(a)-3(c) show magnetic hysteresis loops of [Co₂MnSi (1.2 nm)/Pd]₃ multilayers measured along the outof-plane direction (hereinafter referred to as to M- H_{\perp} loops). It is shown that the coercivity increases significantly after annealing. For the sample annealed at 523 K, the coercivity reaches 2.87 kOe at 5 K, decreasing with increased measuring temperature, as seen in Fig. 3(b). The coercivity of the film annealed at 573 K shows a similar trend [Fig. 3(c)]. However, in this case, we observe a kink in the demagnetized curves for measuring temperatures below 100 K. The hysteresis curve represents a balance of exchange coupling, anisotropy, and dipolar energies, which reflects the domain arrangement [41]. At low temperatures, the magnetization reversal of each layer in the $[Co_2MnSi(1.2 \text{ nm})/Pd]_3$ stack is attributed to domain wall generation and propagation, which is independent of adjacent layers, thus leading to separated switching fields of the individual layers [42].

Figure 3(d) shows the temperature dependences of the normalized out-of-plane saturation magnetization $(M_{s\perp})$ for $[\text{Co}_2\text{MnSi}(1.2 \text{ nm})/\text{Pd}]_3$ multilayers annealed at different temperatures. The $M_{s\perp}$ values increase significantly with decreasing measuring temperature for all multilayers. The measured $M_{s\perp}$ vs *T* data of the annealed samples fit well [dashed line in Fig. 3(d)] to Bloch's law of $M_{s\perp}(T) = M_0 \cdot kBT^{3/2}$, where *k* is the prefactor relating to the interlayer coupling of the multilayer and *B* is the bulk spin-wave parameter [43]. However, in the case of the as-deposited multilayer, the temperature dependence of $M_{s\perp}$ is approximately linear, which is attributed to a relatively reduced surface/interface spin density originating from the disordered structure of Co₂MnSi [43].



FIG. 3. Out-of-plane magnetic hysteresis loops measured within the low-temperature range from 5 to 100 K for $[Co_2MnSi (1.2 \text{ nm})/Pd]_3$ multilayers of the (a) as-deposited and annealed at (b) 523 K and (c) 573 K. (d) $M_{s\perp}$ vs measuring temperature for $[Co_2MnSi (1.2 \text{ nm})/Pd]_3$ multilayers following different annealing temperatures. The dashed lines represent fitting to Bloch's law. The data are normalized by $M_{s\perp}$ values at 10 K.



FIG. 4. ρ_{xy} as a function of *H* for $[Co_2MnSi(1.2 nm)/Pd]_3$ multilayers of the (a) as-deposited and (b) annealed at 573 K, and $[Co_2MnSi(2.1 nm)/Pd]_3$ multilayer annealed at (c) 573 K. The inset of (b) gives the Hall loop measured at 5 K, presenting a consistent kink with the *M*-*H* loop.

C. Anomalous Hall effect (AHE)

In order to elucidate the effect of annealing on AHE, Fig. 4 presents the Hall resistivity ρ_{xy} curves with respect to magnetic field (*H*) applied perpendicularly to the plane for [Co₂MnSi (t_{CMS})/Pd]₃ multilayers following different annealing temperatures (T_{ann}) and Co₂MnSi thicknesses (t_{CMS}). Generally, the magnetic field dependence of ρ_{xy} can be described by [2]

$$\rho_{xy} = \rho_{\text{OH}} + \rho_{\text{AH}} = R_o H + R_s 4\pi M_{s\perp}, \qquad (3)$$

where the $R_o H$ term is the normal Hall resistivity coming from the Lorentz force, and the $R_s 4\pi M_{s\perp}$ term is the quantum mechanical phenomenon of the anomalous Hall resistivity. R_o and R_s are ordinary and anomalous Hall coefficients, respectively, which characterize the strength of these effects. Thus, ρ_{AH} can be extracted from the Hall curve.

As shown in Fig. 4(a) of the as-deposited $[Co_2MnSi (1.2 \text{ nm})/Pd]_3$ multilayer, ρ_{xy} decreases sharply at low *H* with a negative slope, following a linear dependence up to its saturation field, and then further increases with increasing *H*. Based on Eq. (3) and the single-band model [44], it is suggested that the charge carriers are electrons and the AHE has a negative value. However, the value of the AHE turns positive after annealing, as seen in Fig. 4(b), which

may be the result of different orientations of the easy axis of IMA for the as-deposited film and PMA for the film annealed at 573 K. For the $[Co_2MnSi (2.1 nm)/Pd]_3$ multilayer with a thicker Co_2MnSi layer, the field dependence of ρ_{xy} is comparable with that of the $[Co_2MnSi (1.2 nm)/Pd]_3$ multilayer annealed at 573 K. The difference is that the squareness of the Hall loop decreases slightly (i.e., a relatively weak PMA behavior), in agreement with the magnetic hysteresis loops presented earlier. As shown in Fig. 3(c), a kink was observed for the *M*-*H* loops measured at low temperature for the $[Co_2MnSi (1.2 nm)/Pd]_3$ multilayer annealed at 573 K. When the step size of the applied magnetic field was decreased to the value used for the *M*-*H* loops, a consistent kink appears for the Hall loop measured at 5 K [shown in the inset of Fig. 4(b)].

To further clarify the effect of thermal annealing on the AHE in $[Co_2MnSi(t_{CMS})/Pd]_3$ multilayers, Figs. 5(a) and 5(b) plot the temperature-dependent longitudinal resistivity (ρ_{xx}) and anomalous Hall resistivity (ρ_{AH}) for [Co₂MnSi (1.2 nm)/Pd]₃ multilayers following different annealing temperatures (T_{ann}). The value of ρ_{AH} for each measuring temperature was obtained by extrapolating the Hall loops at large applied magnetic field to zero magnetic field. Figure 5(a) shows that ρ_{xx} increases monotonically with measuring temperature for all multilayers. A positive value of temperature coefficient of longitudinal resistivity $(d\rho_{xx}/dT > 0)$ implies metallic behavior. We note that ρ_{xx} increases slightly with T below 20 K, indicating that the main contribution to ρ_{xx} is residual resistivity due to charge scattering of impurities and atomic disorder within the individual layer and at interfaces [22]. According to Matthiessen's rule [45], a slight reduction of residual resistivity is measured for multilayers with increasing T_{ann} to 573 and 623 K, respectively.

As shown in Fig. 5(b), ρ_{AH} displays a weak temperature dependence below 20 K, which is similar to the temperature dependence of ρ_{xx} . Above 20 K, the large decrease (as-deposited multilayers) or increase (annealed multilayers) is observed, implying that phonon-induced resistivity is significant in the multilayer. ρ_{AH} is almost two orders of magnitude smaller than ρ_{xx} . For the as-deposited multilayer, ρ_{AH} increases with the increase of measuring temperature. It is noteworthy that ρ_{AH} decreases nonlinearly with increasing measuring temperature for all annealed multilayers, which also differs from reports for Co₂MnSi monolayer and other multilayer systems such as CoFeB/Pt and Fe/Au [22,24,31], while it is similar to the tendency of Pd/YIG film [46]. For the Pd/YIG system, it is suggested that the magnetic proximity plays an important role in contributing to AHE, which could lead to the decreased ρ_{AH} with increasing measuring temperature [46]. Thus, the observation of measuring temperature dependence of ρ_{AH} in our samples implies that interfacial proximity effects exist in the annealed $[Co_2MnSi(t_{CMS})/Pd]_3$ multilayers and contribute to the AHE resistivity [46]. Considering the particulatelike-layer structures [Figs. 1(b)-1(d)] in the $[Co_2MnSi (1.2 nm)/Pd]_3$ multilayers after thermal annealing, this temperature-dependent ρ_{AH} could be attributed to a strong proximity effect at the Co₂MnSi/Pd interfaces resulting in the contribution of magnetic moments from Pd atoms [46]. Thus, this proximity effect to Pd adjacent to Co2MnSi layer can



FIG. 5. Temperature dependence of (a) ρ_{xx} and (b) ρ_{AH} for $[Co_2MnSi (1.2 \text{ nm})/Pd]_3$ multilayers following different annealing temperatures. (c) ρ_{AH} vs ρ_{xx} fitted with the scaling relation of Eq. (1). (d) T_{ann} dependence of the scaling parameter a', a'', and b, respectively. Inset: T_{ann} -dependent ρ_{ss} and $|\rho_{si}|$ at 5 K.

be enhanced and modified by means of thermal annealing. In addition, it is also found that ρ_{AH} measured at 5 K increases with the increase of T_{ann} by a factor of 26 for the multilayer annealed at 623 K compared to the as-deposited multilayer, although ρ_{xx} remains similar. This remarkable increase can again be attributed to an enhanced proximity effect at the Co₂MnSi/Pd interface after annealing [46].

We apply the scaling relation of Eq. (1) reported by Tian *et al.* [12] in order to determine the charge carrier scattering mechanism of AHE in [Co₂MnSi (1.2 nm)/Pd]₃ multilayers, in particular its dependence on thermal annealing. Figure 5(c) plots ρ_{AH} as a function of ρ_{xx} for the multilayers following different annealing temperatures. A good fit between ρ_{xx} and ρ_{AH} is achieved based on Eq. (1). We note that the residual resistivity ρ_{xx0} is measured at 5 K.

Figure 5(d) presents the variations of the scaling parameters a', a'', and b following annealing temperature. The inset is the dependence of ρ_{ss} and $|\rho_{sj}|$, measured at 5 K, following various annealing temperatures. The bulk intrinsic contribution is negligible in thin films, namely, the $b\rho_{xx}^2$ term dominantly represents the extrinsic contribution of side jump (defined as $\rho_{sj} = b\rho_{xx}^2$). The signs of the scaling parameters a' and a'' are the same, opposite to that of b, indicating that the skewing scattering mechanism has a positive contribution while the side-jump mechanism has a negative contribution to the overall magnitude of AHE. Notably, the scaling parameter a'' is not constant with increasing annealing temperature and larger than a' for all $[Co_2MnSi(1.2 nm)/Pd]_3$ multilayers, especially at annealing temperatures above 523 K. This trend indicates that the contribution of phonons to skew scattering is significant [12,47].

In addition, the value of ρ_{ss} equals 0.11 $\mu\Omega$ cm for the contribution of skew scattering to the AHE mechanism at 5 K in the as-deposited $[Co_2MnSi(1.2 \text{ nm})/Pd]_3$ multilayer, resulting in a weak AHE with relatively small scaling parameters. The $|\rho_{si}|$ value equals 0.09 $\mu\Omega$ cm, which is slightly less than that of the skew scattering causing a low overall AHE in the as-deposited [Co₂MnSi (1.2 nm)/Pd]₃ multilayer. The scaling parameters a' and a'' increase significantly for all annealed multilayers, reaching maximum values of 5.1×10^{-2} and 8.7×10^{-2} near 573 K, respectively. The absolute value of parameter b displays a similar dependence on T_{ann} , reaching a maximum value of $1.6 \times 10^3 \,\Omega^{-1} \text{cm}^{-1}$ near 573 K. The variation of ρ_{ss} and $|\rho_{si}|$ with annealing temperature shows a similar trend to the scaling parameters a' and a''. The largest values of ρ_{ss} and $|\rho_{sj}|$ for $[Co_2MnSi (1.2 \text{ nm})/Pd]_3$ multilayers annealed at 573 K are about 1.34 and 1.1 $\mu\Omega$ cm, respectively. Moreover, ρ_{ss} values in all multilayers are larger than $|\rho_{si}|$, as seen in the inset of Fig. 5(d), implying that skew scattering is strong in [Co₂MnSi (1.2 nm)/Pd]₃ multilayers as compared to the side-jump effect. Here again we observe for $[Co_2MnSi(1.2 \text{ nm})/Pd]_3$ multilayers that thermal annealing influences the Co₂MnSi/Pd interface, thus enabling one to tune AHE behavior. The increased skew scattering and side-jump contribution after annealing may account for the enhanced interfacelike scattering between the Co2MnSi and Pd regions [26].

In order to examine the influence of the thickness of Co₂MnSi layers on AHE in [Co₂MnSi (t_{CMS})/Pd]₃ multilayers, Figs. 6(a) and 6(b) show the temperature dependence of ρ_{xx} and ρ_{AH} for multilayers annealed at 573 K with different Co₂MnSi thicknesses. The temperature-dependent ρ_{xx} for all



FIG. 6. Dependence of (a) ρ_{xx} and (b) ρ_{AH} on measurement temperature for $[Co_2MnSi(t_{CMS})/Pd]_3$ multilayers annealed at 573 K for different t_{CMS} . (c) ρ_{AH} vs ρ_{xx} fitting curves according to Eq. (1). (d) t_{CMS} dependence of the scaling parameters b, a', and a'', respectively. Inset: The dependence of ρ_{ss} and $|\rho_{sj}|$, measured at 5 K, on t_{CMS} .

multilayers exhibits a metallic nature. ρ_{xx} increases with increasing Co₂MnSi thickness, particularly at t_{CMS} beyond 1.2 nm. ρ_{xx} increases by a factor of 1.5 when t_{CMS} increases from 0.7 to 2.1 nm at 5 K owing to the increased contributions from Co₂MnSi layers. However, ρ_{AH} decreases by a factor close to 1.5 with increasing t_{CMS} to 2.1 nm. This observation is consistent with the interpretation of the weakened PMA in the multilayers in a relatively thick Co₂MnSi layer, attributed to a reduced interface proximity effect.

Figure 6(c) shows good fitting of the relation of ρ_{xx} dependent ρ_{AH} with the scaling approximation of Eq. (1) for [Co₂MnSi (t_{CMS})/Pd]₃ multilayers for different Co₂MnSi thicknesses (t_{CMS}). The scaling parameters of a', a'', and bas a function of t_{CMS} are plotted in Fig. 6(d). The inset is the dependence of ρ_{ss} and $|\rho_{sj}|$, measured at 5 K, on t_{CMS} . The scaling parameters of a' and a'' decrease nearly linearly with the increase of t_{CMS} , and the absolute value of parameter balso shows a trend to decrease with increasing t_{CMS} . This trend implies that skew scattering and side-jump contributions to AHE are reduced with increasing t_{CMS} . As shown in the inset of Fig. 6(d), ρ_{ss} values in all multilayers are larger than $|\rho_{sj}|$ values, indicating that the skew scattering contributes to the overall AHE in contrast to the side-jump mechanism [47].

Thus, by varying the thickness and annealing temperature of the Co₂MnSi layers, the interfacial interaction can be finely tuned, leading to the enhanced AHE in $[Co_2MnSi (t_{CMS})/Pd]_3$ multilayers. The dependence of AHE on the measurement temperature can be ascribed to the proximity effect at the Co₂MnSi/Pd interface, which again can be tuned by varying the annealing temperature and Co₂MnSi thickness [46].

IV. CONCLUSIONS

We reported a systematic study on the role of Co₂MnSi thickness and annealing temperature in $[Co_2MnSi(t_{CMS})/Pd]_3$ multilayers on PMA and AHE. By varying the annealing temperature and Co₂MnSi thickness, a large PMA was achieved for the case of the $[Co_2MnSi(1.2 nm)/Pd]_3$ multilayer annealed at 573 K with a $K_{\rm eff}$ value of $1.2 \times 10^6 \, {\rm erg/cm^3}$. The relationship between the longitudinal resistivity (ρ_{xx}) and anomalous Hall resistivity (ρ_{AH}) are well fitted by the expanded AHE scaling relation. We show quantitatively the opposite contributions of skew scattering and side-jump mechanisms to AHE in $[Co_2MnSi(t_{CMS})/Pd]_3$ multilayers and carefully tune the Co₂MnSi thickness and annealing temperature to achieve a controllable AHE behavior by balancing the skew scattering and side-jump origins, which is useful for the development and application of AHE-based devices.

ACKNOWLEDGMENTS

This work was in part supported by the National Natural Science Foundation of China (Grants No. 51771145 and No. 51371140), Shaanxi key R & D plan, international scientific and technological cooperation and exchange program (Grant No. 2017KW-020), Natural Science Basic Research Plan of Shaanxi Province (Grants No. 2017JM5060 and No. 2018JQ1066), and the ISF-NSFC joint research program (Grant No. 2223/15).

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